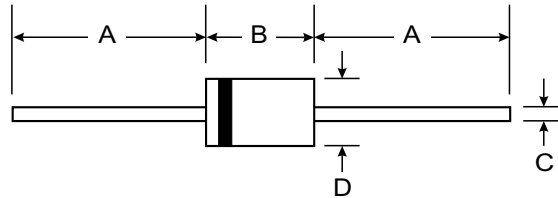


Features

- Low profile, axial leaded outline
- High frequency operation
- Very low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Lead (Pb)-free plating
- Designed and qualified for industrial level



DO-201AD		
Dim	Min	Max
A	25.40	—
B	7.20	9.50
C	1.20	1.30
D	4.80	5.30
All Dimensions in mm		

Mechanical Data

- Case: molded plastic

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

SYMBOL	CHARACTERISTICS	VALUES	UNITS
I _{F(AV)}	Rectangular waveform	3.3	A
V _{RRM}		50/60	V
I _{FSM}	t _p = 5 μs sine	340	A
V _F	3 Apk, T _J = 25 °C	0.62	V
T _J		- 40 to 150	°C

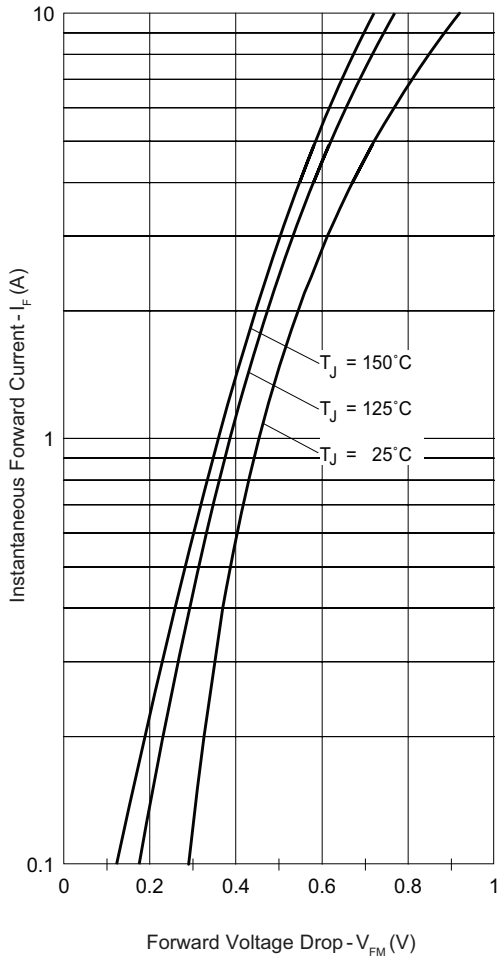


Fig. 1 - Maximum Forward Voltage Drop Characteristics

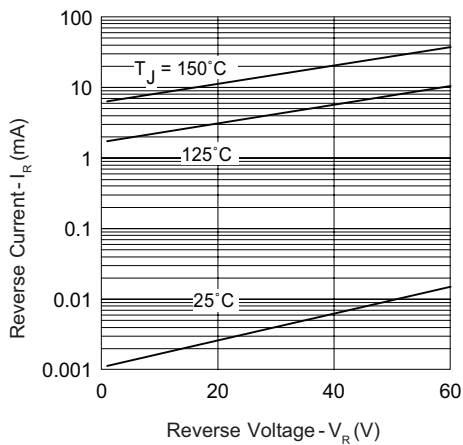


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

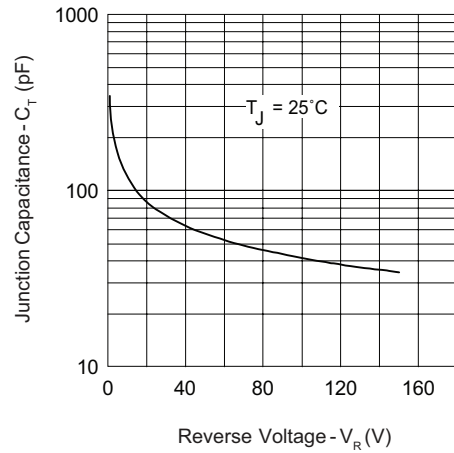


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

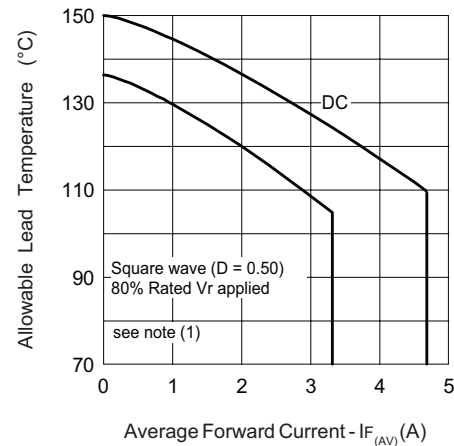


Fig. 4 - Maximum Allowable Lead Temperature vs. Average Forward Current

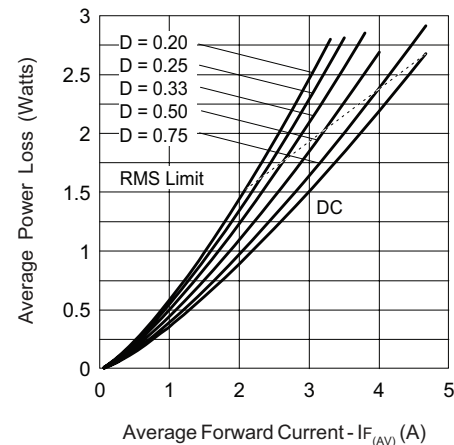


Fig. 5 - Forward Power Loss Characteristics

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); Pd_{REV} = Inverse power loss = $V_{R1} \times I_{R1} (1 - D)$; I_{R1} at $V_{R1} = 80\%$ rated V_R

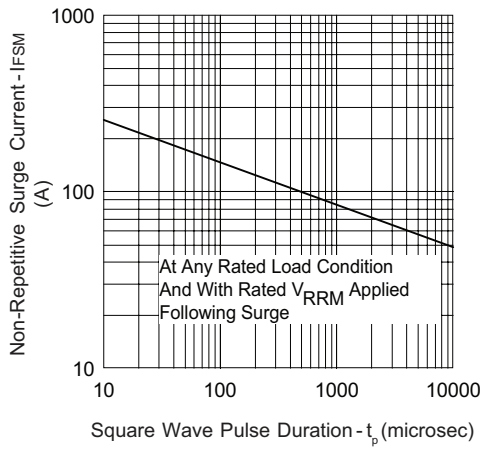


Fig. 6 - Maximum Non-Repetitive Surge Current